Intel - 10AS032E4F29E3LG Datasheet

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Embedded - System On Chip (SoC): The Heart of Modern Embedded Systems

Embedded - System On Chip (SoC) refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

What are Embedded - System On Chip (SoC)?

System On Chip (SoC) integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions, SoCs combine a central

Details	
Product Status	Active
Architecture	MCU, FPGA
Core Processor	Dual ARM® Cortex®-A9 MPCore™ with CoreSight™
Flash Size	-
RAM Size	256KB
Peripherals	DMA, POR, WDT
Connectivity	EBI/EMI, Ethernet, I²C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	1.5GHz
Primary Attributes	FPGA - 320K Logic Elements
Operating Temperature	0°C ~ 100°C (TJ)
Package / Case	780-BBGA, FCBGA
Supplier Device Package	780-FBGA, FC (29x29)
Purchase URL	https://www.e-xfl.com/product-detail/intel/10as032e4f29e3lg

Intel® Arria® 10 Device Overview

The Intel® Arria® 10 device family consists of high-performance and power-efficient 20 nm mid-range FPGAs and SoCs.

Intel Arria 10 device family delivers:

- Higher performance than the previous generation of mid-range and high-end FPGAs.
- Power efficiency attained through a comprehensive set of power-saving technologies.

The Intel Arria 10 devices are ideal for high performance, power-sensitive, midrange applications in diverse markets.

Table 1. Sample Markets and Ideal Applications for Intel Arria 10 Devices

Market	Applications
Wireless	• Channel and switch cards in remote radio heads • Mobile backhaul
Wireline	• 40G/100G muxponders and transponders • 100G line cards • Bridging • Aggregation
Broadcast	• Studio switches • Servers and transport • Videoconferencing • Professional audio and video
Computing and Storage	• Flash cache • Cloud computing servers • Server acceleration
Medical	• Diagnostic scanners • Diagnostic imaging
Military	• Missile guidance and control • Radar • Electronic warfare • Secure communications

Related Information

Intel Arria 10 Device Handbook: Known Issues

Lists the planned updates to the *Intel Arria 10 Device Handbook* chapters.

Key Advantages of Intel Arria 10 Devices

Table 2. Key Advantages of the Intel Arria 10 Device Family

Advantage	Supporting Feature
Enhanced core architecture	• Built on TSMC's 20 nm process technology • 60% higher performance than the previous generation of mid-range FPGAs • 15% higher performance than the fastest previous-generation FPGA
High-bandwidth integrated transceivers	• Short-reach rates up to 25.8 Gigabits per second (Gbps) • Backplane capability up to 12.5 Gbps • Integrated 10GBASE-KR and 40GBASE-KR4 Forward Error Correction (FEC)
Improved logic integration and hard IP blocks	• 8-input adaptive logic module (ALM) • Up to 65.6 megabits (Mb) of embedded memory • Variable-precision digital signal processing (DSP) blocks • Fractional synthesis phase-locked loops (PLLs) • Hard PCI Express Gen3 IP blocks • Hard memory controllers and PHY up to 2,400 Megabits per second (Mbps)
Second generation hard processor system (HPS) with integrated ARM* Cortex*-A9* MPCore* processor	• Tight integration of a dual-core ARM Cortex-A9 MPCore processor, hard IP, and an FPGA in a single Intel Arria 10 system-on-a-chip (SoC) • Supports over 128 Gbps peak bandwidth with integrated data coherency between the processor and the FPGA fabric
Advanced power savings	• Comprehensive set of advanced power saving features • Power-optimized MultiTrack routing and core architecture • Up to 40% lower power compared to previous generation of mid-range FPGAs • Up to 60% lower power compared to previous generation of high-end FPGAs

Summary of Intel Arria 10 Features

Table 3. Summary of Features for Intel Arria 10 Devices

Feature	Description
Technology	• TSMC's 20-nm SoC process technology • Allows operation at a lower V_{CC} level of 0.82 V instead of the 0.9 V standard V_{CC} core voltage
Packaging	• 1.0 mm ball-pitch Fineline BGA packaging • 0.8 mm ball-pitch Ultra Fineline BGA packaging • Multiple devices with identical package footprints for seamless migration between different FPGA densities • Devices with compatible package footprints allow migration to next generation high-end Stratix® 10 devices • RoHS, leaded(1), and lead-free (Pb-free) options
High-performance FPGA fabric	• Enhanced 8-input ALM with four registers • Improved multi-track routing architecture to reduce congestion and improve compilation time • Hierarchical core clocking architecture • Fine-grained partial reconfiguration
Internal memory blocks	• M20K—20-Kb memory blocks with hard error correction code (ECC) • Memory logic array block (MLAB)—640-bit memory

continued...

(1) Contact Intel for availability.

Feature	Description	
Embedded Hard IP blocks	Variable-precision DSP	• Native support for signal processing precision levels from 18 x 19 to 54 x 54 • Native support for 27 x 27 multiplier mode • 64-bit accumulator and cascade for systolic finite impulse responses (FIRs) • Internal coefficient memory banks • Preadder/subtractor for improved efficiency • Additional pipeline register to increase performance and reduce power • Supports floating point arithmetic: — Perform multiplication, addition, subtraction, multiply-add, multiply-subtract, and complex multiplication. — Supports multiplication with accumulation capability, cascade summation, and cascade subtraction capability. — Dynamic accumulator reset control. — Support direct vector dot and complex multiplication chaining multiply floating point DSP blocks.
	Memory controller	DDR4, DDR3, and DDR3L
	PCI Express*	PCI Express (PCIe*) Gen3 (x1, x2, x4, or x8), Gen2 (x1, x2, x4, or x8) and Gen1 (x1, x2, x4, or x8) hard IP with complete protocol stack, endpoint, and root port
	Transceiver I/O	• 10GBASE-KR/40GBASE-KR4 Forward Error Correction (FEC) • PCS hard IPs that support: — 10-Gbps Ethernet (10GbE) — PCIe PIPE interface — Interlaken — Gbps Ethernet (GbE) — Common Public Radio Interface (CPRI) with deterministic latency support — Gigabit-capable passive optical network (GPON) with fast lock-time support • 13.5G JESD204b • 8B/10B, 64B/66B, 64B/67B encoders and decoders • Custom mode support for proprietary protocols
Core clock networks	• Up to 800 MHz fabric clocking, depending on the application: — 667 MHz external memory interface clocking with 2,400 Mbps DDR4 interface — 800 MHz LVDS interface clocking with 1,600 Mbps LVDS interface • Global, regional, and peripheral clock networks • Clock networks that are not used can be gated to reduce dynamic power	
Phase-locked loops (PLLs)	• High-resolution fractional synthesis PLLs: — Precision clock synthesis, clock delay compensation, and zero delay buffering (ZDB) — Support integer mode and fractional mode — Fractional mode support with third-order delta-sigma modulation • Integer PLLs: — Adjacent to general purpose I/Os — Support external memory and LVDS interfaces	
FPGA General-purpose I/Os (GPIOs)	• 1.6 Gbps LVDS—every pair can be configured as receiver or transmitter • On-chip termination (OCT) • 1.2 V to 3.0 V single-ended LVTTL/LVCMOS interfacing	
External Memory Interface	• Hard memory controller— DDR4, DDR3, and DDR3L support — DDR4—speeds up to 1,200 MHz/2,400 Mbps — DDR3—speeds up to 1,067 MHz/2,133 Mbps • Soft memory controller—provides support for RLDRAM 3(2), QDR IV(2), and QDR II+	

continued...

Feature	Description	
Low-power serial transceivers	• Continuous operating range: — Intel Arria 10 GX—1 Gbps to 17.4 Gbps — Intel Arria 10 GT—1 Gbps to 25.8 Gbps • Backplane support: — Intel Arria 10 GX—up to 12.5 — Intel Arria 10 GT—up to 12.5 • Extended range down to 125 Mbps with oversampling • ATX transmit PLLs with user-configurable fractional synthesis capability • Electronic Dispersion Compensation (EDC) support for XFP, SFP+, QSFP, and CFP optical module • Adaptive linear and decision feedback equalization • Transmitter pre-emphasis and de-emphasis • Dynamic partial reconfiguration of individual transceiver channels	
HPS (Intel Arria 10 SX devices only)	Processor and system	• Dual-core ARM Cortex-A9 MPCore processor—1.2 GHz CPU with 1.5 GHz overdrive capability • 256 KB on-chip RAM and 64 KB on-chip ROM • System peripherals—general-purpose timers, watchdog timers, direct memory access (DMA) controller, FPGA configuration manager, and clock and reset managers • Security features—anti-tamper, secure boot, Advanced Encryption Standard (AES) and authentication (SHA) • ARM CoreSight* JTAG debug access port, trace port, and on-chip trace storage
	External interfaces	• Hard memory interface—Hard memory controller (2,400 Mbps DDR4, and 2,133 Mbps DDR3), Quad serial peripheral interface (QSPI) flash controller, NAND flash controller, direct memory access (DMA) controller, Secure Digital/MultiMediaCard (SD/MMC) controller • Communication interface— 10/100/1000 Ethernet media access control (MAC), USB On-The-GO (OTG) controllers, I^2C controllers, UART 16550, serial peripheral interface (SPI), and up to 62 HPS GPIO interfaces (48 direct-share I/Os)
	Interconnects to core	• High-performance ARM AMBA* AXI bus bridges that support simultaneous read and write • HPS–FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa • Configuration bridge that allows HPS configuration manager to configure the core logic via dedicated 32-bit configuration port • FPGA-to-HPS SDRAM controller bridge—provides configuration interfaces for the multiport front end (MPFE) of the HPS SDRAM controller
Configuration	• Tamper protection—comprehensive design protection to protect your valuable IP investments • Enhanced 256-bit advanced encryption standard (AES) design security with authentication • Configuration via protocol (CvP) using PCIe Gen1, Gen2, or Gen3	

continued...

(2) Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.

Feature	Description
	• Dynamic reconfiguration of the transceivers and PLLs • Fine-grained partial reconfiguration of the core fabric • Active Serial x4 Interface
Power management	• SmartVID • Low static power device options • Programmable Power Technology • Intel Quartus Prime integrated power analysis
Software and tools	• Intel Quartus Prime design suite • Transceiver toolkit • Platform Designer system integration tool • DSP Builder for Intel FPGAs • OpenCL™ support • Intel SoC FPGA Embedded Design Suite (EDS)

Related Information

Intel Arria 10 Transceiver PHY Overview
Provides details on Intel Arria 10 transceivers.

Intel Arria 10 Device Variants and Packages

Table 4. Device Variants for the Intel Arria 10 Device Family

Variant	Description
Intel Arria 10 GX	FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.
Intel Arria 10 GT	FPGA featuring: • 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability. • 25.8 Gbps transceivers for supporting CAUI-4 and CEI-25G applications with CFP2 and CFP4 modules.
Intel Arria 10 SX	SoC integrating ARM-based HPS and FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.

Intel Arria 10 GX

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GX devices.

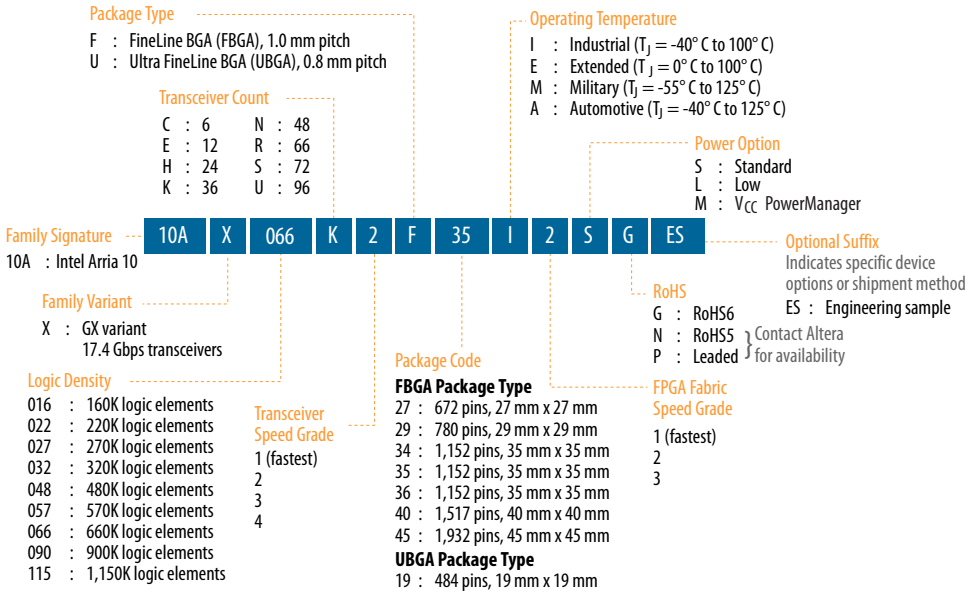
The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

Related Information

Intel FPGA Product Selector
Provides the latest information on Intel products.

Available Options

Figure 1. Sample Ordering Code and Available Options for Intel Arria 10 GX Devices



Related Information

Transceiver Performance for Intel Arria 10 GX/SX Devices
Provides more information about the transceiver speed grade.

Table 6. Maximum Resource Counts for Intel Arria 10 GX Devices (GX 570, GX 660, GX 900, and GX 1150)

Resource		Product Line			
		GX 570	GX 660	GX 900	GX 1150
Logic Elements (LE) (K)		570	660	900	1,150
ALM		217,080	251,680	339,620	427,200
Register		868,320	1,006,720	1,358,480	1,708,800
Memory (Kb)	M20K	36,000	42,620	48,460	54,260
	MLAB	5,096	5,788	9,386	12,984
Variable-precision DSP Block		1,523	1,687	1,518	1,518
18 x 19 Multiplier		3,046	3,374	3,036	3,036
PLL	Fractional Synthesis	16	16	32	32
	I/O	16	16	16	16
17.4 Gbps Transceiver		48	48	96	96
GPIO (3)		696	696	768	768
LVDS Pair (4)		324	324	384	384
PCIe Hard IP Block		2	2	4	4
Hard Memory Controller		16	16	16	16

Package Plan

Table 7. Package Plan for Intel Arria 10 GX Devices (U19, F27, and F29)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	U19 (19 mm × 19 mm, 484-pin UBGA)			F27 (27 mm × 27 mm, 672-pin FBGA)			F29 (29 mm × 29 mm, 780-pin FBGA)		
	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR
GX 160	48	192	6	48	192	12	48	240	12
GX 220	48	192	6	48	192	12	48	240	12
GX 270	—	—	—	48	192	12	48	312	12
GX 320	—	—	—	48	192	12	48	312	12
GX 480	—	—	—	—	—	—	48	312	12

Maximum Resources

Table 10. Maximum Resource Counts for Intel Arria 10 GT Devices

Resource		Product Line	
		GT 900	GT 1150
Logic Elements (LE) (K)		900	1,150
ALM		339,620	427,200
Register		1,358,480	1,708,800
Memory (Kb)	M20K	48,460	54,260
	MLAB	9,386	12,984
Variable-precision DSP Block		1,518	1,518
18 x 19 Multiplier		3,036	3,036
PLL	Fractional Synthesis	32	32
	I/O	16	16
Transceiver	17.4 Gbps	72 (5)	72 (5)
	25.8 Gbps	6	6
GPIO(6)		624	624
LVDS Pair(7)		312	312
PCIe Hard IP Block		4	4
Hard Memory Controller		16	16

Related Information

Intel Arria 10 GT Channel Usage
Configuring GT/GX channels in Intel Arria 10 GT devices.

Package Plan

Table 11. Package Plan for Intel Arria 10 GT Devices

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	SF45 (45 mm × 45 mm, 1932-pin FBGA)		
	3 V I/O	LVDS I/O	XCVR
GT 900	—	624	72
GT 1150	—	624	72

(5) If all 6 GT channels are in use, 12 of the GX channels are not usable.

(6) The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

(7) Each LVDS I/O pair can be used as differential input or output.

Related Information

I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook
Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.

Intel Arria 10 SX

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 SX devices.

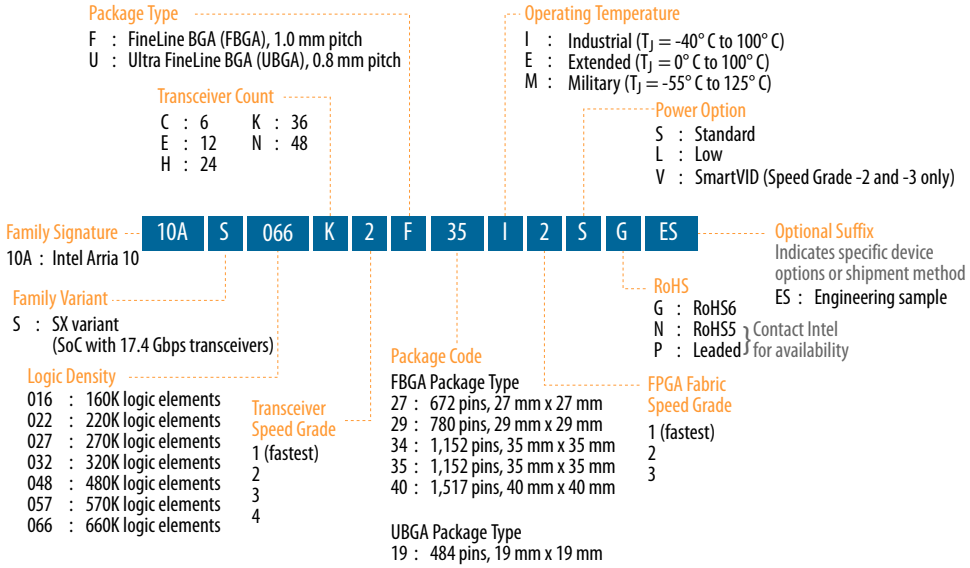
The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

Related Information

Intel FPGA Product Selector
Provides the latest information on Intel products.

Available Options

Figure 3. Sample Ordering Code and Available Options for Intel Arria 10 SX Devices



Related Information

Transceiver Performance for Intel Arria 10 GX/SX Devices
Provides more information about the transceiver speed grade.

Product Line	U19 (19 mm × 19 mm, 484-pin UBGA)			F27 (27 mm × 27 mm, 672-pin FBGA)			F29 (29 mm × 29 mm, 780-pin FBGA)			F34 (35 mm × 35 mm, 1152-pin FBGA)		
	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR
SX 480	—	—	—	—	—	—	48	312	12	48	444	24
SX 570	—	—	—	—	—	—	—	—	—	48	444	24
SX 660	—	—	—	—	—	—	—	—	—	48	444	24

Table 14. Package Plan for Intel Arria 10 SX Devices (F35, KF40, and NF40)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

Product Line	F35 (35 mm × 35 mm, 1152-pin FBGA)			KF40 (40 mm × 40 mm, 1517-pin FBGA)			NF40 (40 mm × 40 mm, 1517-pin FBGA)		
	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR	3 V I/O	LVDS I/O	XCVR
SX 270	48	336	24	—	—	—	—	—	—
SX 320	48	336	24	—	—	—	—	—	—
SX 480	48	348	36	—	—	—	—	—	—
SX 570	48	348	36	96	600	36	48	540	48
SX 660	48	348	36	96	600	36	48	540	48

Related Information

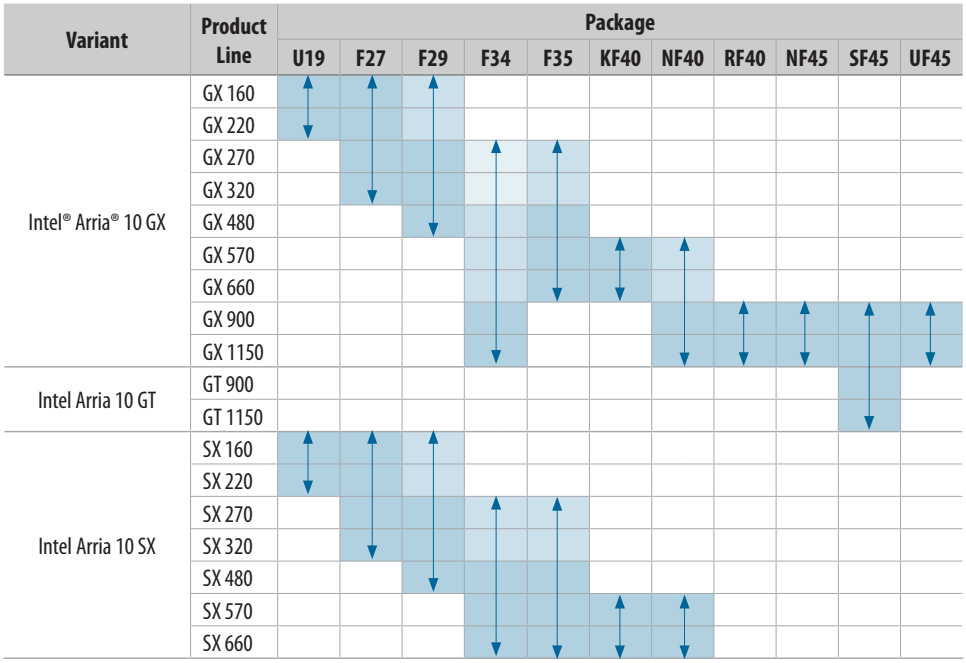
I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.

I/O Vertical Migration for Intel Arria 10 Devices

Figure 4. Migration Capability Across Intel Arria 10 Product Lines

- The arrows indicate the migration paths. The devices included in each vertical migration path are shaded. Devices with fewer resources in the same path have lighter shades.
- To achieve the full I/O migration across product lines in the same migration path, restrict I/Os and transceivers usage to match the product line with the lowest I/O and transceiver counts.
- An LVDS I/O bank in the source device may be mapped to a 3 V I/O bank in the target device. To use memory interface clock frequency higher than 533 MHz, assign external memory interface pins only to banks that are LVDS I/O in both devices.
- There may be nominal 0.15 mm package height difference between some product lines in the same package type.
- Some migration paths are not shown in the Intel Quartus Prime software **Pin Migration View**.



Note: To verify the pin migration compatibility, use the **Pin Migration View** window in the Intel Quartus Prime software Pin Planner.

Adaptive Logic Module

Intel Arria 10 devices use a 20 nm ALM as the basic building block of the logic fabric.

The ALM architecture is the same as the previous generation FPGAs, allowing for efficient implementation of logic functions and easy conversion of IP between the device generations.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than the traditional two-register per LUT architecture.

Types of Embedded Memory

The Intel Arria 10 devices contain two types of memory blocks:

- 20 Kb M20K blocks—blocks of dedicated memory resources. The M20K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide and shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Intel Arria 10 devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB.

Embedded Memory Capacity in Intel Arria 10 Devices

Table 18. Embedded Memory Capacity and Distribution in Intel Arria 10 Devices

Variant	Product Line	M20K		MLAB		Total RAM Bit (Kb)
		Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	
Intel Arria 10 GX	GX 160	440	8,800	1,680	1,050	9,850
	GX 220	587	11,740	2,703	1,690	13,430
	GX 270	750	15,000	3,922	2,452	17,452
	GX 320	891	17,820	4,363	2,727	20,547
	GX 480	1,431	28,620	6,662	4,164	32,784
	GX 570	1,800	36,000	8,153	5,096	41,096
	GX 660	2,131	42,620	9,260	5,788	48,408
	GX 900	2,423	48,460	15,017	9,386	57,846
	GX 1150	2,713	54,260	20,774	12,984	67,244
Intel Arria 10 GT	GT 900	2,423	48,460	15,017	9,386	57,846
	GT 1150	2,713	54,260	20,774	12,984	67,244
Intel Arria 10 SX	SX 160	440	8,800	1,680	1,050	9,850
	SX 220	587	11,740	2,703	1,690	13,430
	SX 270	750	15,000	3,922	2,452	17,452
	SX 320	891	17,820	4,363	2,727	20,547
	SX 480	1,431	28,620	6,662	4,164	32,784
	SX 570	1,800	36,000	8,153	5,096	41,096
	SX 660	2,131	42,620	9,260	5,788	48,408

The fractional synthesis PLLs support the following features:

- Reference clock frequency synthesis for transceiver CMU and Advanced Transmit (ATX) PLLs
- Clock network delay compensation
- Zero-delay buffering
- Direct transmit clocking for transceivers
- Independently configurable into two modes:
  - Conventional integer mode equivalent to the general purpose PLL
  - Enhanced fractional mode with third order delta-sigma modulation
- PLL cascading

I/O PLLs

The integer mode I/O PLLs are located in each bank of 48 I/Os. You can use the I/O PLLs to simplify the design of external memory and high-speed LVDS interfaces.

In each I/O bank, the I/O PLLs are adjacent to the hard memory controllers and LVDS SERDES. Because these PLLs are tightly coupled with the I/Os that need to use them, it makes it easier to close timing.

You can use the I/O PLLs for general purpose applications in the core such as clock network delay compensation and zero-delay buffering.

Intel Arria 10 devices support PLL-to-PLL cascading.

FPGA General Purpose I/O

Intel Arria 10 devices offer highly configurable GPIOs. Each I/O bank contains 48 general purpose I/Os and a high-efficiency hard memory controller.

The following list describes the features of the GPIOs:

- Consist of 3 V I/Os for high-voltage application and LVDS I/Os for differential signaling
  - Up to two 3 V I/O banks, available in some devices, that support up to 3 V I/O standards
  - LVDS I/O banks that support up to 1.8 V I/O standards
- Support a wide range of single-ended and differential I/O interfaces
- LVDS speeds up to 1.6 Gbps
- Each LVDS pair of pins has differential input and output buffers, allowing you to configure the LVDS direction for each pair.
- Programmable bus hold and weak pull-up
- Programmable differential output voltage (V_{OD}) and programmable pre-emphasis

Related Information

Intel Arria 10 Device Datasheet
Lists the memory interface performance according to memory interface standards, rank or chip select configurations, and Intel Arria 10 device speed grades.

PCIe Gen1, Gen2, and Gen3 Hard IP

Intel Arria 10 devices contain PCIe hard IP that is designed for performance and ease-of-use:

- Includes all layers of the PCIe stack—transaction, data link and physical layers.
- Supports PCIe Gen3, Gen2, and Gen1 Endpoint and Root Port in x1, x2, x4, or x8 lane configuration.
- Operates independently from the core logic—optional configuration via protocol (CvP) allows the PCIe link to power up and complete link training in less than 100 ms while the Intel Arria 10 device completes loading the programming file for the rest of the FPGA.
- Provides added functionality that makes it easier to support emerging features such as Single Root I/O Virtualization (SR-IOV) and optional protocol extensions.
- Provides improved end-to-end datapath protection using ECC.
- Supports FPGA configuration via protocol (CvP) using PCIe at Gen3, Gen2, or Gen1 speed.

Related Information

PCS Features on page 30

Enhanced PCS Hard IP for Interlaken and 10 Gbps Ethernet

Interlaken Support

The Intel Arria 10 enhanced PCS hard IP provides integrated Interlaken PCS supporting rates up to 25.8 Gbps per lane.

The Interlaken PCS is based on the proven functionality of the PCS developed for Intel's previous generation FPGAs, which demonstrated interoperability with Interlaken ASSP vendors and third-party IP suppliers. The Interlaken PCS is present in every transceiver channel in Intel Arria 10 devices.

Related Information

PCS Features on page 30

10 Gbps Ethernet Support

The Intel Arria 10 enhanced PCS hard IP supports 10GBASE-R PCS compliant with IEEE 802.3 10 Gbps Ethernet (10GbE). The integrated hard IP support for 10GbE and the 10 Gbps transceivers save external PHY cost, board space, and system power.

Each transceiver channel contains a channel PLL that can be used as the CMU PLL or clock data recovery (CDR) PLL. In CDR mode, the channel PLL recovers the receiver clock and data in the transceiver channel. Up to 80 independent data rates can be configured on a single Intel Arria 10 device.

Table 23. PMA Features of the Transceivers in Intel Arria 10 Devices

Feature	Capability
Chip-to-Chip Data Rates	1 Gbps to 17.4 Gbps (Intel Arria 10 GX devices) 1 Gbps to 25.8 Gbps (Intel Arria 10 GT devices)
Backplane Support	Drive backplanes at data rates up to 12.5 Gbps
Optical Module Support	SFP+/SFP, XFP, CXP, QSFP/QSFP28, CFP/CFP2/CFP4
Cable Driving Support	SFP+ Direct Attach, PCI Express over cable, eSATA
Transmit Pre-Emphasis	4-tap transmit pre-emphasis and de-emphasis to compensate for system channel loss
Continuous Time Linear Equalizer (CTLE)	Dual mode, high-gain, and high-data rate, linear receive equalization to compensate for system channel loss
Decision Feedback Equalizer (DFE)	7-fixed and 4-floating tap DFE to equalize backplane channel loss in the presence of crosstalk and noisy environments
Variable Gain Amplifier	Optimizes the signal amplitude prior to the CDR sampling and operates in fixed and adaptive modes
Altera Digital Adaptive Parametric Tuning (ADAPT)	Fully digital adaptation engine to automatically adjust all link equalization parameters—including CTLE, DFE, and variable gain amplifier blocks—that provide optimal link margin without intervention from user logic
Precision Signal Integrity Calibration Engine (PreSICE)	Hardened calibration controller to quickly calibrate all transceiver control parameters on power-up, which provides the optimal signal integrity and jitter performance
Advanced Transmit (ATX) PLL	Low jitter ATX (LC tank based) PLLs with continuous tuning range to cover a wide range of standard and proprietary protocols
Fractional PLLs	On-chip fractional frequency synthesizers to replace on-board crystal oscillators and reduce system cost
Digitally Assisted Analog CDR	Superior jitter tolerance with fast lock time
Dynamic Partial Reconfiguration	Allows independent control of the Avalon memory-mapped interface of each transceiver channel for the highest transceiver flexibility
Multiple PCS-PMA and PCS-PLD interface widths	8-, 10-, 16-, 20-, 32-, 40-, or 64-bit interface widths for flexibility of deserialization width, encoding, and reduced latency

PCS Features

This table summarizes the Intel Arria 10 transceiver PCS features. You can use the transceiver PCS to support a wide range of protocols ranging from 1 Gbps to 25.8 Gbps.

PCS	Description
Standard PCS	• Operates at a data rate up to 12 Gbps • Supports protocols such as PCI-Express, CPRI 4.2+, GigE, IEEE 1588 in Hard PCS • Implements other protocols using Basic/Custom (Standard PCS) transceiver configuration rules.
Enhanced PCS	• Performs functions common to most serial data industry standards, such as word alignment, encoding/decoding, and framing, before data is sent or received off-chip through the PMA • Handles data transfer to and from the FPGA fabric • Handles data transfer internally to and from the PMA • Provides frequency compensation • Performs channel bonding for multi-channel low skew applications
PCIe Gen3 PCS	• Supports the seamless switching of Data and Clock between the Gen1, Gen2, and Gen3 data rates • Provides support for PIPE 3.0 features • Supports the PIPE interface with the Hard IP enabled, as well as with the Hard IP bypassed

Related Information

- PCIe Gen1, Gen2, and Gen3 Hard IP on page 26
- Interlaken Support on page 26
- 10 Gbps Ethernet Support on page 26

PCS Protocol Support

This table lists some of the protocols supported by the Intel Arria 10 transceiver PCS. For more information about the blocks in the transmitter and receiver data paths, refer to the related information.

Protocol	Data Rate (Gbps)	Transceiver IP	PCS Support
PCIe Gen3 x1, x2, x4, x8	8.0	Native PHY (PIPE)	Standard PCS and PCIe Gen3 PCS
PCIe Gen2 x1, x2, x4, x8	5.0	Native PHY (PIPE)	Standard PCS
PCIe Gen1 x1, x2, x4, x8	2.5	Native PHY (PIPE)	Standard PCS
1000BASE-X Gigabit Ethernet	1.25	Native PHY	Standard PCS
1000BASE-X Gigabit Ethernet with IEEE 1588v2	1.25	Native PHY	Standard PCS
10GBASE-R	10.3125	Native PHY	Enhanced PCS
10GBASE-R with IEEE 1588v2	10.3125	Native PHY	Enhanced PCS
10GBASE-R with KR FEC	10.3125	Native PHY	Enhanced PCS
10GBASE-KR and 1000BASE-X	10.3125	1G/10GbE and 10GBASE-KR PHY	Standard PCS and Enhanced PCS
Interlaken (CEI-6G/11G)	3.125 to 17.4	Native PHY	Enhanced PCS
SFI-S/SFI-5.2	11.2	Native PHY	Enhanced PCS
10G SDI	10.692	Native PHY	Enhanced PCS

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Protocol	Data Rate (Gbps)	Transceiver IP	PCS Support
CPRI 6.0 (64B/66B)	0.6144 to 10.1376	Native PHY	Enhanced PCS
CPRI 4.2 (8B/10B)	0.6144 to 9.8304	Native PHY	Standard PCS
OBSAI RP3 v4.2	0.6144 to 6.144	Native PHY	Standard PCS
SD-SDI/HD-SDI/3G-SDI	0.143[(12)] to 2.97	Native PHY	Standard PCS

Related Information

Intel Arria 10 Transceiver PHY User Guide
Provides more information about the supported transceiver protocols and PHY IP, the PMA architecture, and the standard, enhanced, and PCIe Gen3 PCS architecture.

SoC with Hard Processor System

Each SoC device combines an FPGA fabric and a hard processor system (HPS) in a single device. This combination delivers the flexibility of programmable logic with the power and cost savings of hard IP in these ways:

- Reduces board space, system power, and bill of materials cost by eliminating a discrete embedded processor
- Allows you to differentiate the end product in both hardware and software, and to support virtually any interface standard
- Extends the product life and revenue through in-field hardware and software updates

(12) The 0.143 Gbps data rate is supported using oversampling of user logic that you must implement in the FPGA fabric.

Scheme	Data Width	Max Clock Rate (MHz)	Max Data Rate (Mbps) (13)	Decompression	Design Security (14)	Partial Reconfiguration (15)	Remote System Update
Fast passive parallel (FPP) through CPLD or external microcontroller	8 bits	100	3200	Yes	Yes	Yes(17)	PFL IP core
	16 bits			Yes	Yes		
	32 bits			Yes	Yes		
Configuration via HPS	16 bits	100	3200	Yes	Yes	Yes(17)	—
	32 bits			Yes	Yes		
Configuration via Protocol [CvP (PCIe*)]	x1, x2, x4, x8 lanes	—	8000	Yes	Yes	Yes(16)	—

You can configure Intel Arria 10 devices through PCIe using Configuration via Protocol (CvP). The Intel Arria 10 CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.

SEU Error Detection and Correction

Intel Arria 10 devices offer robust and easy-to-use single-event upset (SEU) error detection and correction circuitry.

The detection and correction circuitry includes protection for Configuration RAM (CRAM) programming bits and user memories. The CRAM is protected by a continuously running CRC error detection circuit with integrated ECC that automatically corrects one or two errors and detects higher order multi-bit errors. When more than two errors occur, correction is available through reloading of the core programming file, providing a complete design refresh while the FPGA continues to operate.

The physical layout of the Intel Arria 10 CRAM array is optimized to make the majority of multi-bit upsets appear as independent single-bit or double-bit errors which are automatically corrected by the integrated CRAM ECC circuitry. In addition to the CRAM protection, the M20K memory blocks also include integrated ECC circuitry and are layout-optimized for error detection and correction. The MLAB does not have ECC.

Power Management

Intel Arria 10 devices leverage the advanced 20 nm process technology, a low 0.9 V core power supply, an enhanced core architecture, and several optional power reduction techniques to reduce total power consumption by as much as 40% compared to Arria V devices and as much as 60% compared to Stratix V devices.

(13) Enabling either compression or design security features affects the maximum data rate. Refer to the Intel Arria 10 Device Datasheet for more information.
(14) Encryption and compression cannot be used simultaneously.
(15) Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Intel for support.

(17) Supported at a maximum clock rate of 100 MHz.

Date	Version	Changes
		• Removed package code 40, low static power, SmartVID, industrial, and military operating temperature support from *Sample Ordering Core and Available Options for Intel Arria 10 GT Devices* figure. • Updated short reach transceiver rate for Intel Arria 10 GT devices to 25.8 Gbps. • Removed On-Die Instrumentation — EyeQ and Jitter Margin Tool support from *PMA Features of the Transceivers in Intel Arria 10 Devices* table.
September 2017	2017.09.20	Updated the maximum speed of the DDR4 external memory interface from 1,333 MHz/2,666 Mbps to 1,200 MHz/2,400 Mbps.
July 2017	2017.07.13	Corrected the automotive temperature range in the figure showing the available options for the Intel Arria 10 GX devices from "-40°C to 100°C" to "-40°C to 125°C".
July 2017	2017.07.06	Added automotive temperature option to Intel Arria 10 GX device family.
May 2017	2017.05.08	• Corrected protocol names with "1588" to "IEEE 1588v2". • Updated the vertical migration table to remove vertical migration between Intel Arria 10 GX and Intel Arria 10 SX device variants. • Removed all "Preliminary" marks.
March 2017	2017.03.15	• Removed the topic about migration from Intel Arria 10 to Intel Stratix 10 devices. • Rebranded as Intel.
October 2016	2016.10.31	• Removed package F36 from Intel Arria 10 GX devices. • Updated Intel Arria 10 GT sample ordering code and maximum GX transceiver count. Intel Arria 10 GT devices are available only in the SF45 package option with a maximum of 72 transceivers.
May 2016	2016.05.02	• Updated the FPGA Configuration and HPS Booting topic. • Remove V_{CC} PowerManager from the Summary of Features, Power Management and Arria 10 Device Variants and packages topics. This feature is no longer supported in Arria 10 devices. • Removed LPDDR3 from the Memory Standards Supported by the HPS Hard Memory Controller table in the Memory Standards Supported by Intel Arria 10 Devices topic. This standard is only supported by the FPGA. • Removed transceiver speed grade 5 from the Device Variants and Packages topic for Arria 10 GX and SX devices.
February 2016	2016.02.11	• Changed the maximum Arria 10 GT datarate to 25.8 Gbps and the minimum datarate to 1 Gbps globally. • Revised the state for Core clock networks in the Summary of Features topic. • Changed the transceiver parameters in the "Summary of Features for Arria 10 Devices" table. • Changed the transceiver parameters in the "Maximum Resource Counts for Arria 10 GT Devices" table. • Changed the package availability for GT devices in the "Package Plan for Arria 10 GT Devices" table. • Changed the package configurations for GT devices in the "Migration Capability Across Arria 10 Product Lines" figure. • Changed transceiver parameters in the "Low Power Serial Transceivers" section. • Changed the transceiver descriptions in the "Device Variants for the Arria 10 Device Family" table. • Changed the "Sample Ordering Code and Available Options for Arria 10 GT Devices" figure. • Changed the datarates for GT devices in the "PMA Features" section. • Changed the datarates for GT devices in the "PCS Features" section.

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Date	Version	Changes
August 2014	2014.08.18	• Updated Memory (Kb) M20K maximum resources for Arria 10 GX 660 devices from 42,660 to 42,620. • Added GPIO columns consisting of LVDS I/O Bank and 3V I/O Bank in the Package Plan table. • Added how to use memory interface clock frequency higher than 533 MHz in the I/O vertical migration. • Added information to clarify that RLDRAM3 support uses hard PHY with soft memory controller. • Added variable precision DSP blocks support for floating-point arithmetic.
June 2014	2014.06.19	Updated number of dedicated I/Os in the HPS block to 17.
February 2014	2014.02.21	Updated transceiver speed grade options for GT devices in Figure 2.
February 2014	2014.02.06	Updated data rate for Arria 10 GT devices from 28.1 Gbps to 28.3 Gbps.
December 2013	2013.12.10	• Updated the HPS memory standards support from LPDDR2 to LPDDR3. • Updated HPS block diagram to include dedicated HPS I/O and FPGA Configuration blocks as well as repositioned SD/SDIO/MMC, DMA, SPI and NAND Flash with ECC blocks .
December 2013	2013.12.02	Initial release.